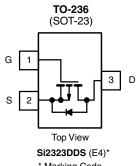


**Vishay Siliconix** 

## P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω) Max.	I <sub>D</sub> (A) <sup>d</sup>	Q <sub>g</sub> (Typ.)			
	0.039 at V <sub>GS</sub> = - 4.5 V	- 5.3				
- 20	0.050 at V <sub>GS</sub> = - 2.5 V	- 4.7	13.6 nC			
	0.075 at V <sub>GS</sub> = - 1.8 V	- 3.8				



\* Marking Code

#### **FEATURES**

- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>a</sub> Tested
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



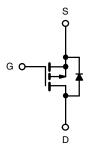
RoHS

COMPLIANT HALOGEN

FREE

### **APPLICATIONS**

- Load Switch
- PA Switch
- **DC/DC** Converters
- **Power Management**



P-Channel MOSFET

1

Ordering Information:
Si2323DDS-T1-GE3 (Lead (Pb)-free and Halogen-free)

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C, unless otherwise noted)					
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V <sub>DS</sub>	- 20	v	
Gate-Source Voltage		V <sub>GS</sub>	± 8	v	
	T <sub>C</sub> = 25 °C		- 5.3		
	T <sub>C</sub> = 70 °C	۱ <sub>D</sub>	- 4.3		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C		- 4.1 <sup>a,b</sup>		
	T <sub>A</sub> = 70 °C		- 3.2 <sup>a,b</sup>	А	
Pulsed Drain Current (t = 300 µs)	I <sub>DM</sub>	- 20			
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	- I <sub>S</sub>	- 1.4		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C		- 0.8 <sup>a,b</sup>		
	T <sub>C</sub> = 25 °C		1.7		
Marian Distriction	T <sub>C</sub> = 70 °C		1.1	14/	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	PD	0.96 <sup>a,b</sup>	W	
	T <sub>A</sub> = 70 °C		0.62 <sup>a,b</sup>		
Operating Junction and Storage Temperature Rat	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>a, c</sup>	$t \le 5 s$	R <sub>thJA</sub>	100	130	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	60	75		

Notes:

a. Surface mounted on 1" x 1" FR4 board.

c. Maximum under steady state conditions is 175  $^{\circ}\text{C/W}.$ 

d. T<sub>C</sub> = 25 °C.

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b. t = 5 s.

### Vishay Siliconix



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	•	· · · · · · · · · · · · · · · · · · ·		•			
Drain-Source Breakdown Voltage	Voltage $V_{DS}$ $V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$		- 20			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = - 250 μA		- 13		mV/°0	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_D = -250 \mu A$		- 2.8			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 0.4		- 1	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V$ , $V_{GS} = \pm 8 V$			± 100	nA	
Zana Cata Valtana Duain Commant	1	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$			- 1	μΑ	
Zero Gate Voltage Drain Current	DSS	$V_{DS}$ = - 20 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C			- 10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le$ - 5 V, $V_{GS}$ = - 4.5 V	- 15			Α	
		V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 4.1 A		0.032	0.039	Ω	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 2.5 V, I <sub>D</sub> = - 2 A		0.041	0.050		
	20(01)	V <sub>GS</sub> = - 1.8 V, I <sub>D</sub> = - 1 A		0.058	0.075	-	
Forward Transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 4.1 A		18		S	
Dynamic <sup>b</sup>					I		
Input Capacitance	C <sub>iss</sub>			1160		pF	
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz		135			
Reverse Transfer Capacitance	C <sub>rss</sub>			120			
Total Gate Charge	Q <sub>g</sub>	$V_{DS} = -10 \text{ V}, V_{GS} = -8 \text{ V}, I_{D} = -4.1 \text{ A}$		24	36		
Total Gate Charge	Q <sub>g</sub>			13.6	21	nC	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 4.1 A		2			
Gate-Drain Charge	Q <sub>gd</sub>			2.2			
Gate Resistance	R <sub>g</sub>	f = 1 MHz	2	10	20	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>		-	24	36		
Rise Time	t <sub>r</sub>	$V_{DD} = -10 \text{ V}, \text{ R}_{1} = 3.1 \Omega$		22	40	-	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong -3.2 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_q = 1 \Omega$		52	78		
Fall Time	t <sub>f</sub>	B GEN Sg		11	20		
Turn-On Delay Time	t <sub>d(on)</sub>			8	16	ns	
Rise Time	t <sub>r</sub>	V <sub>DD</sub> = - 10 V, R <sub>I</sub> = 3.1 Ω		9	18	-	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong -3.2 \text{ A}, \text{ V}_{\text{GEN}} = -8 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		58	87		
Fall Time	τ <sub>f</sub>			9	18		
Drain-Source Body Diode Characterist				5	10		
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			- 1.4		
Pulse Diode Forward Current	I <sub>SM</sub>	<u> </u>			- 20	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = - 3.2 A, V <sub>GS</sub> = 0 V		- 0.79	- 1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			14	25	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			6	12	nC	
Reverse Recovery Fall Time	$r_{\rm r} = -3.2$ A, dl/dt = 100 A/us, $r_{\rm r} = 25$ °C			8			
Reverse Recovery Rise Time	t <sub>b</sub>			6		ns	

Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

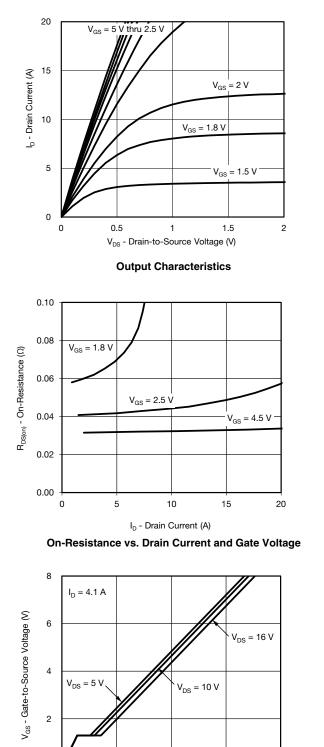
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

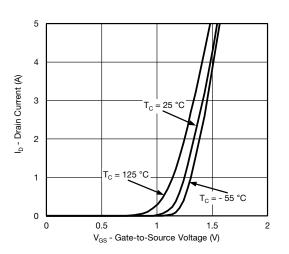
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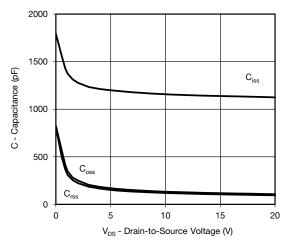
### Si2323DDS Vishay Siliconix

### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

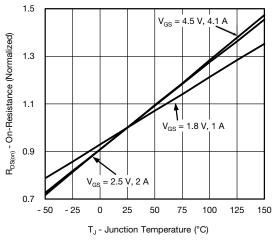




**Transfer Characteristics** 



Capacitance



**On-Resistance vs. Junction Temperature** 

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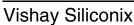
21

28

14

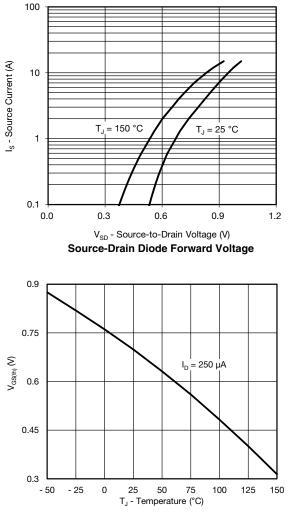
 $Q_{\alpha}$  - Total Gate Charge (nC)

**Gate Charge** 

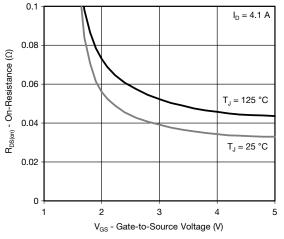




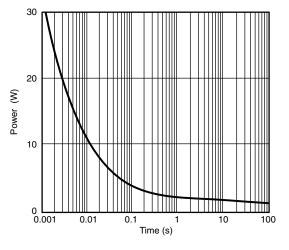
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



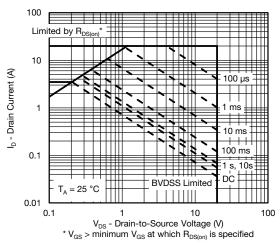
**Threshold Voltage** 



**On-Resistance vs. Gate-to-Source Voltage** 



Single Pulse Power, Junction-to-Ambient



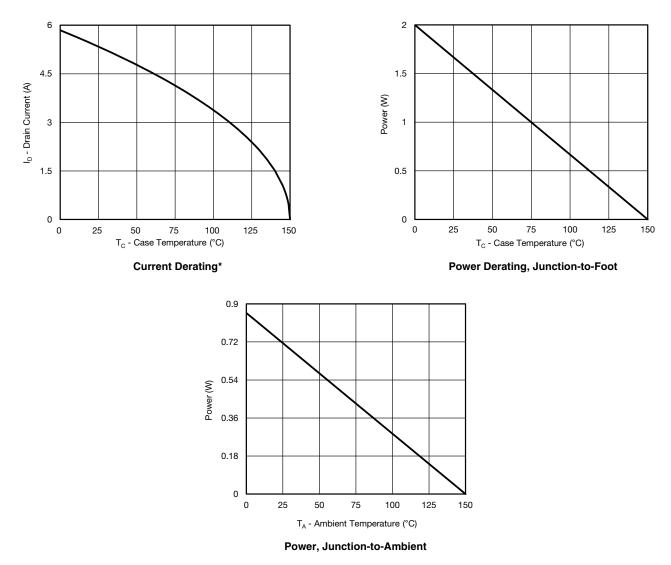
Safe Operating Area, Junction-to-Ambient

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

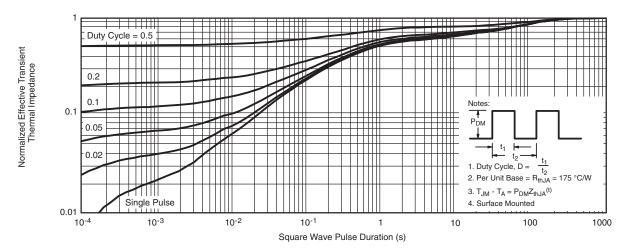


\* The power dissipation  $P_D$  is based on  $T_{J(max.)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

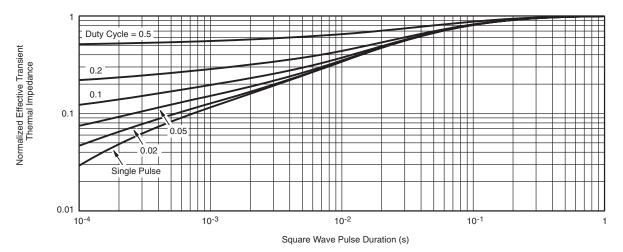


**Vishay Siliconix** 

### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?64004">www.vishay.com/ppg?64004</a>.

www.vishay.com 6 For technical questions, contact: pmostechsupport@vishay.com

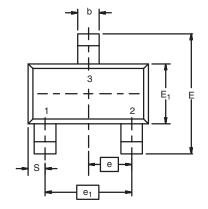
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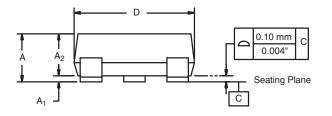


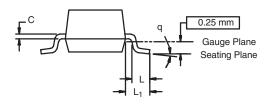
## Package Information

Vishay Siliconix

### SOT-23 (TO-236): 3-LEAD







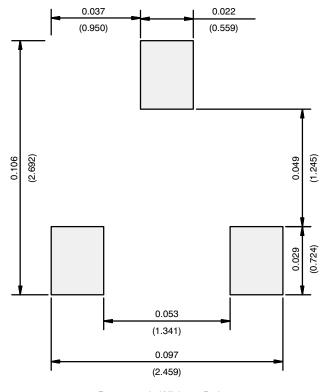
Dim	MILLIN	IETERS	INCHES			
	Min	Max	Min	Мах		
Α	0.89	1.12	0.035	0.044		
A <sub>1</sub>	0.01	0.10	0.0004	0.004		
A <sub>2</sub>	0.88	1.02	0.0346	0.040		
b	0.35	0.50	0.014	0.020		
С	0.085	0.18	0.003	0.007		
D	2.80	3.04	0.110	0.120		
E	2.10	2.64	0.083	0.104		
E <sub>1</sub>	1.20	1.40	0.047	0.055		
е	0.95 BSC		0.0374 Ref			
e <sub>1</sub>	1.90 BSC		0.074	748 Ref		
L	0.40	0.60	0.016	0.024		
L <sub>1</sub>	0.64 Ref		0.02	5 Ref		
S	0.50 Ref		0.020	) Ref		
q	3°	8°	3°	8°		
ECN: S-03946-Rev. K, 09- DWG: 5479	Jul-01					



# Application Note 826

Vishay Siliconix

### **RECOMMENDED MINIMUM PADS FOR SOT-23**



Recommended Minimum Pads Dimensions in Inches/(mm)

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